





- **M1:** Characterisation of the diodes and readout electronics of unirradiated and irradiated RD50-MPW1 samples (Q4/2018) → Achieved
 - **M1.2 (new):** Design and submission of RD50-MPW2 (Q1/2019) → Achieved
 - **M1.3 (new):** Characterisation of unirradiated and irradiated RD50-MPW2 samples (Q1/2020 → Q3/2021) → Achieved
 - **M1.4 (new):** Design and submission of RD50-MPW3 (Q1/2021 → Q4/2021) → Achieved
 - **M1.5 (new):** Characterisation of unirradiated and irradiated RD50-MPW3 samples, including CERN/DESY test beams (Q3/2022 → Q2/2023) → To do
- **M2:** Design and submission for fabrication of RD50-ENGRUN1 (Q4/2018)
- **M3:** Characterisation of unirradiated and irradiated RD50-ENGRUN1 samples (Q3/2019, Q3/2020)
- **M4:** Characterisation of irradiated backside biased RD50-ENGRUN1 samples for operation beyond $10^{16} n_{eq}/cm$ (Q4/2020)
- **M5:** Studies of stitching process options (Q4/2021)
- **M6:** Characterisation of unirradiated and irradiated stitched samples (Q4/2022)